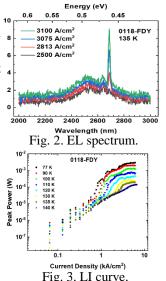
Electrically Injected GeSn Lasers towards **Room Temperature**



Graduate School

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Background/Relevance			Ар	Approach		
•	Use of group IV ma	terials for semiconductors offers man	iy •	A PIN-doped GeSn wafer was prepared by		Cr/Au electrode
benefits compared to traditional group III-V materials.				 chemical vapor deposition and wet etching. Electrodes were deposited and wire bonded to a Si carrier chip to form a PIN-diode. 		p+-type SiGeSn cap
•	GeSn has a direct bandgap above 8% Sn composition, making it ideal for use in optoelectronic devices.					p-type SiGeSn cap
•	GeSn is complementary metal-oxide-semiconductor (CMOS)		5)	·	Cr/Au	i-type GeSn active region
	compatible and has p	otential applications in infrared imagin		pulsed voltage source.	electrode	n+-type GeSn buffer
	and light detection and	d ranging (LIDAR) technology.	·	Electroluminescence (EL) was measured		n+-type Ge buffer
Innovation				using Fourier-transform IR spectroscopy.		Si substrate
•	Electrically injected GeSn lasers have not yet been extensively		y •	Light output v. current (LI) curves were		SI substrate
	researched. Higher op	erating temperatures for such devices a	e	generated at various temperatures and used	Fig.	1. Cross section
	desired in order to incr	ease use in applications.		to determine the lasing threshold.		of device.
Key Results			Co	Conclusions		
•	The PIN-diode successfully exhibited $\frac{2}{135 \text{ K}}$		•	• The device successfully lased at mid-IR wavelengths.		
	rectification	6 - 2500 A/cm ²	-			N 11 1

- The EL spectrum shows that the ٠ device lases at a wavelength of 2688 nm at the maximum temperature.
- Lasing occurred at temperatures as high as 135 K.
- The LI curve shows a threshold current density of 701 A/cm² at 77 K. The threshold current density at 135 K is 2813 A/cm².



- The maximum operating temperature of the GeSn PIN-diode device was measured to be 135 K, beating the previous world record by 25 K.
- Alterations in material growth and device structure need to be studied in order to further increase operating temperature. Room temperature use is desired.
- High power eye safe mid-IR wavelengths of light can be generated ٠ by GeSn lasers. One potential application of such a device is in LIDAR technologies.

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